

DOCKET NO. 01-C-084 (STMI01-01084)  
Customer No. 30425

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: : Henry Michael Siegel, et al.

For : SYSTEM AND METHOD FOR USING A PRE-FORMED FILM  
IN A TRANSFER MOLDING PROCESS FOR AN  
INTEGRATED CIRCUIT

BOX PATENT APPLICATION

Commissioner for Patents  
Washington, D. C. 20231

Sir:

ATTORNEY CORRESPONDENCE ADDRESS

Please direct future correspondence and telephone calls relating to this patent application to the  
following:

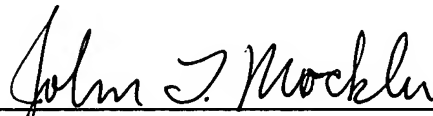
Lisa K. Jorgenson, Esq.  
STMicroelectronics, Inc.  
1310 Electronics Drive  
Carrollton, Texas 75006

Phone: (972) 462-6000  
Fax: (972) 466-7044

Respectfully submitted,

NOVAKOV DAVIS & MUNCK, P.C.

Date: 31 January 2002

  
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John T. Mockler  
Registration No. 39,775

P.O. Box 802432  
Dallas, Texas 75380  
Phone: (214) 922-9221  
Fax: (214) 969-7557  
E-mail: [jmockler@novakov.com](mailto:jmockler@novakov.com)

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